

LS-MM311G-02AI

1.25Gbps SFP Transceiver, Multi Mode, 2km Reach

Product Features

- Supports up to 1.25Gbps bit rates
- Hot-pluggable SFP footprint
- 1310nm FP laser and PIN photo detector, Up to 2km for MMF transmission
- Compliant with SFP MSA and SFF-8472 with duplex LC receptacle
- Compatible with RoHS
- Single +3.3V power supply
- Real Time Digital Diagnostic Monitoring
- Operating case temperature:
Standard: 0 to +70°C
Industrial: -40 to +85°C

Applications

- 1.25Gbps Optical systems
- Gigabit Ethernet
- 1.063Gbps Fiber Channel
- Other Optical links

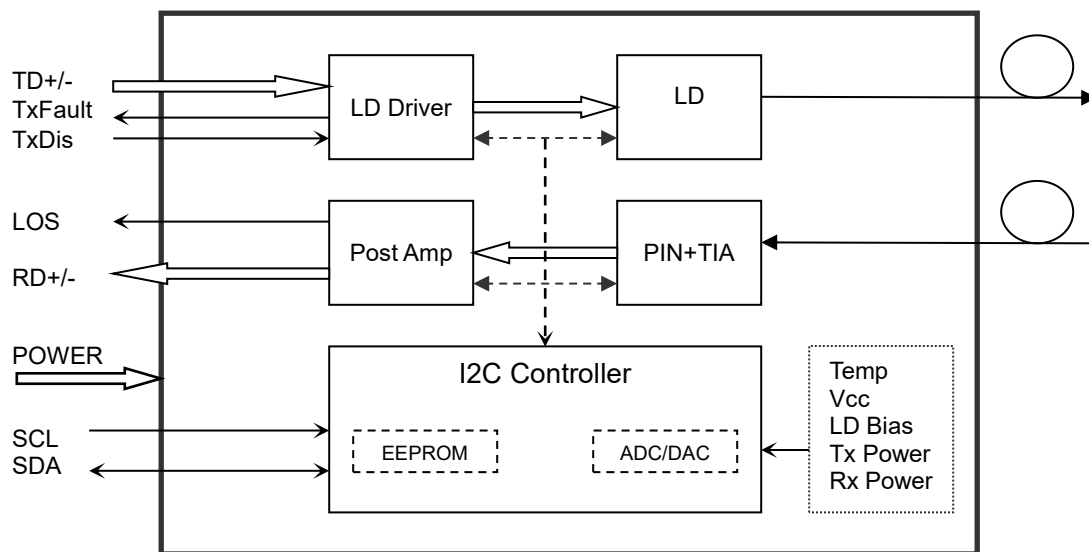


Description

The SFP transceivers are high performance, cost effective modules supporting data rate of 1.25Gbps and 2km transmission distance with MMF.

The transceiver consists of three sections: a FP laser transmitter, a PIN photodiode integrated with a trans-impedance preamplifier (TIA) and MCU control unit. All modules satisfy class I laser safety requirements.

The transceivers are compatible with SFP Multi-Source Agreement and SFF-8472 digital diagnostics functions.



Transceiver functional diagram

Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit
Supply Voltage	Vcc	-0.5	4.5	V
Storage Temperature	Ts	-40	+85	°C
Operating Humidity	-	5	95	%

Recommended Operating Conditions

Parameter	Symbol	Min	Typical	Max	Unit
Operating Case Temperature	Standard	0		+70	°C
	Extended	-20		+85	°C
	Industrial	-40		+85	°C
Power Supply Voltage	Vcc	3.135	3.30	3.465	V
Power Supply Current	Icc			300	mA
Data Rate		0.1	1.25		Gbps

Optical and Electrical Characteristics

Parameter		Symbol	Min	Typical	Max	Unit	Notes
Transmitter							
Centre Wavelength		λ_c	1260	1310	1360	nm	
Spectral Width (RMS)		$\Delta\lambda$			3	nm	
Side-Mode Suppression Ratio		SMSR	-	-	-	dB	
Average Output Power		P _{out}	-12		-3	dBm	1
Extinction Ratio		ER	9.0			dB	
Data Input Swing Differential		V _{IN}	180		1200	mV	2
Input Differential Impedance		Z _{IN}	90	100	110	Ω	
TX Disable	Disable		2.0		V _{cc}	V	
	Enable		0		0.8	V	
TX Fault	Fault		2.0		V _{cc}	V	
	Normal		0		0.8	V	
Receiver							
Centre Wavelength		λ_c	1260		1610	nm	
Receiver Sensitivity					-30	dBm	3
Receiver Overload			-1			dBm	3
LOS De-Assert		LOSD			-30	dBm	
LOS Assert		LOSA	-38			dBm	
LOS Hysteresis			0.5		4	dB	
Data Output Swing Differential		V _{out}	600	800	1000	mV	4
LOS	High		2.0		V _{cc}	V	
	Low				0.8	V	

Notes:

1. The optical power is launched into MMF.
2. PECL input, internally AC-coupled and terminated.
3. Measured with a PRBS 2⁷-1 test pattern @1250Mbps, BER ≤1×10⁻¹².
4. Internally AC-coupled.

Timing and Electrical

Parameter	Symbol	Min	Typical	Max	Unit
Tx Disable Negate Time	t_on			1	ms
Tx Disable Assert Time	t_off			10	μs
Time To Initialize, including Reset of Tx Fault	t_init			300	ms
Tx Fault Assert Time	t_fault			100	μs
Tx Disable To Reset	t_reset	10			μs
LOS Assert Time	t_loss_on			100	μs
LOS De-assert Time	t_loss_off			100	μs
Serial ID Clock Rate	f_serial_clock		100	400	KHz
MOD_DEF (0:2)-High	V _H	2		V _{cc}	V
MOD_DEF (0:2)-Low	V _L			0.8	V

Diagnostics

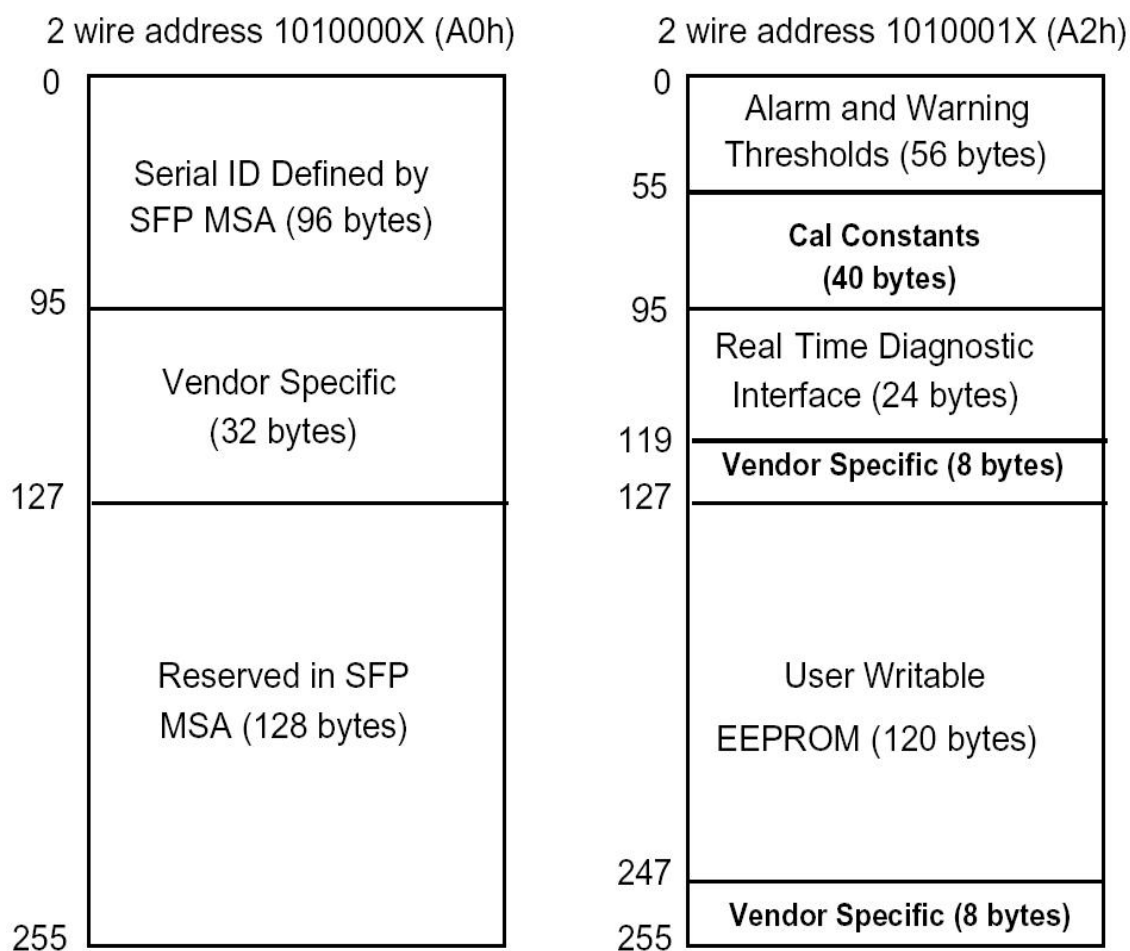
Parameter	Range	Unit	Accuracy	Calibration
Temperature	0 to +70	°C	± 3°C	Internal
	-20 to +85			
	-40 to +85			
Voltage	3.0 to 3.6	V	± 3%	Internal
Bias Current	0 to 100	mA	± 10%	Internal
TX Power	-12 to -3	dBm	± 3dB	Internal
RX Power	-23 to -1	dBm	± 3dB	Internal

Digital Diagnostic Memory Map

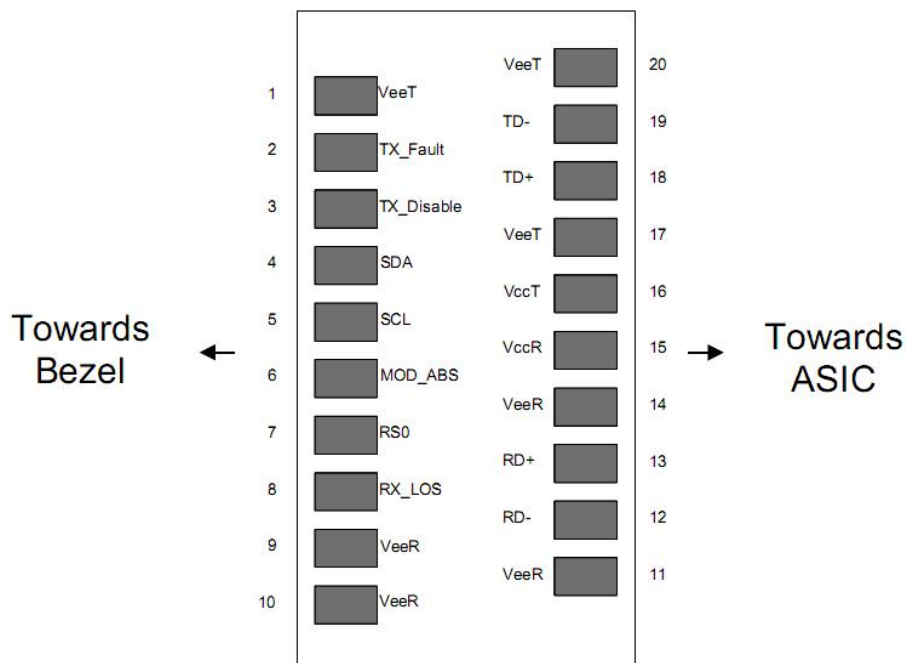
The transceivers provide serial ID memory contents and diagnostic information about the present operating conditions by the 2-wire serial interface (SCL, SDA).

The diagnostic information with internal calibration or external calibration all are implemented, including received power monitoring, transmitted power monitoring, bias current monitoring, supply voltage monitoring and temperature monitoring.

The digital diagnostic memory map specific data field defines as following.



Pin Descriptions



Pin	Signal Name	Description	Plug Seq.	Notes
1	V _{EET}	Transmitter Ground	1	
2	TX_FAULT	Transmitter Fault Indication	3	Note 1
3	TX_DISABLE	Transmitter Disable	3	Note 2
4	SDA	SDA Serial Data Signal	3	
5	SCL	SCL Serial Clock Signal	3	
6	MOD_ABS	Module Absent. Grounded within the module	3	
7	RS0	Not Connected	3	
8	LOS	Loss of Signal	3	Note 3
9	V _{EER}	Receiver ground	1	
10	V _{EER}	Receiver ground	1	
11	V _{EER}	Receiver ground	1	
12	RD-	Inv. Received Data Out	3	Note 4
13	RD+	Received Data Out	3	Note 4
14	V _{EER}	Receiver ground	1	
15	V _{CCR}	Receiver Power Supply	2	
16	V _{CCT}	Transmitter Power Supply	2	
17	V _{EET}	Transmitter Ground	1	

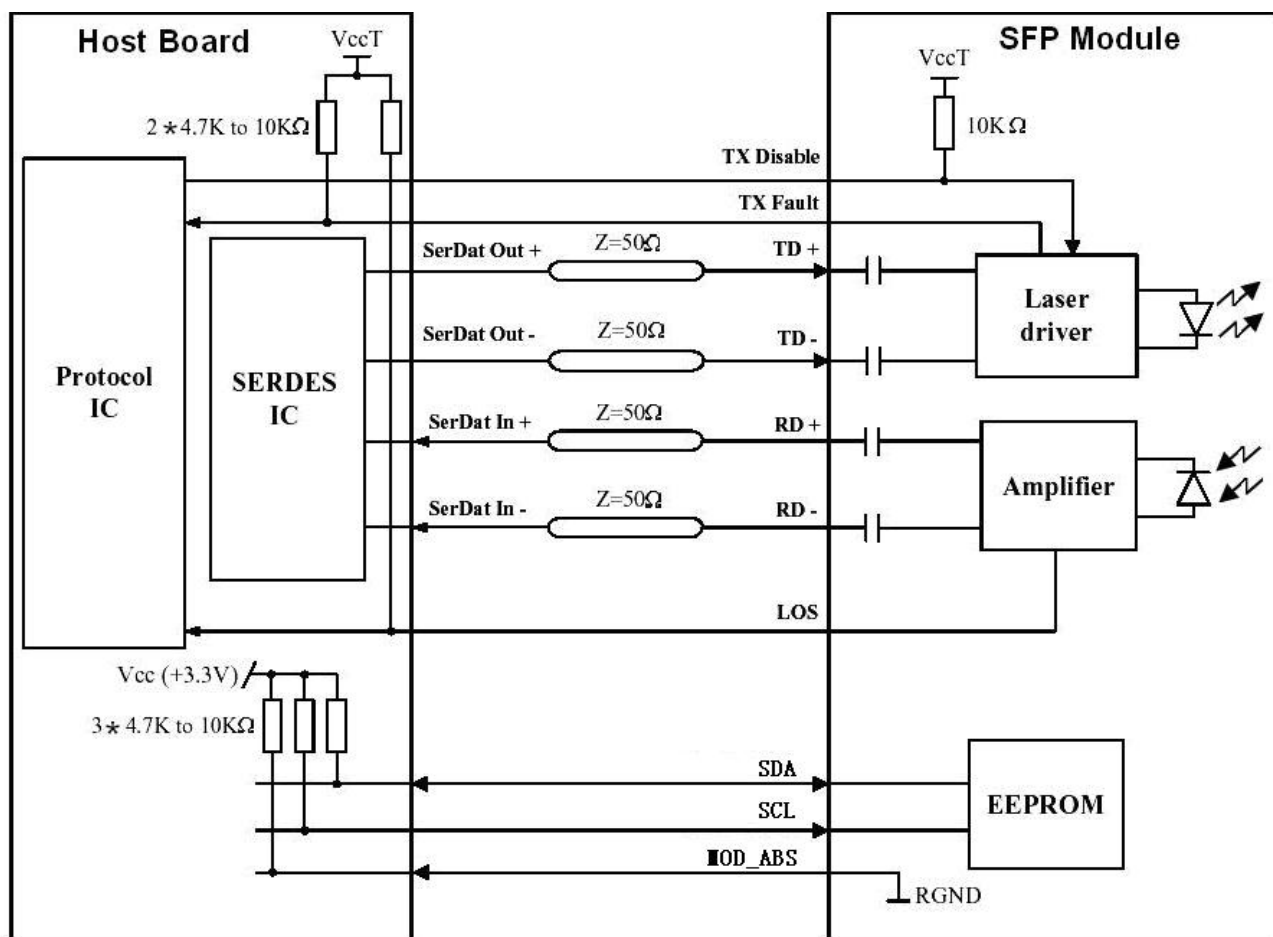
18	TD+	Transmit Data In	3	Note 5
19	TD-	Inv. Transmit Data In	3	Note 5
20	V _{EET}	Transmitter Ground	1	

Notes:

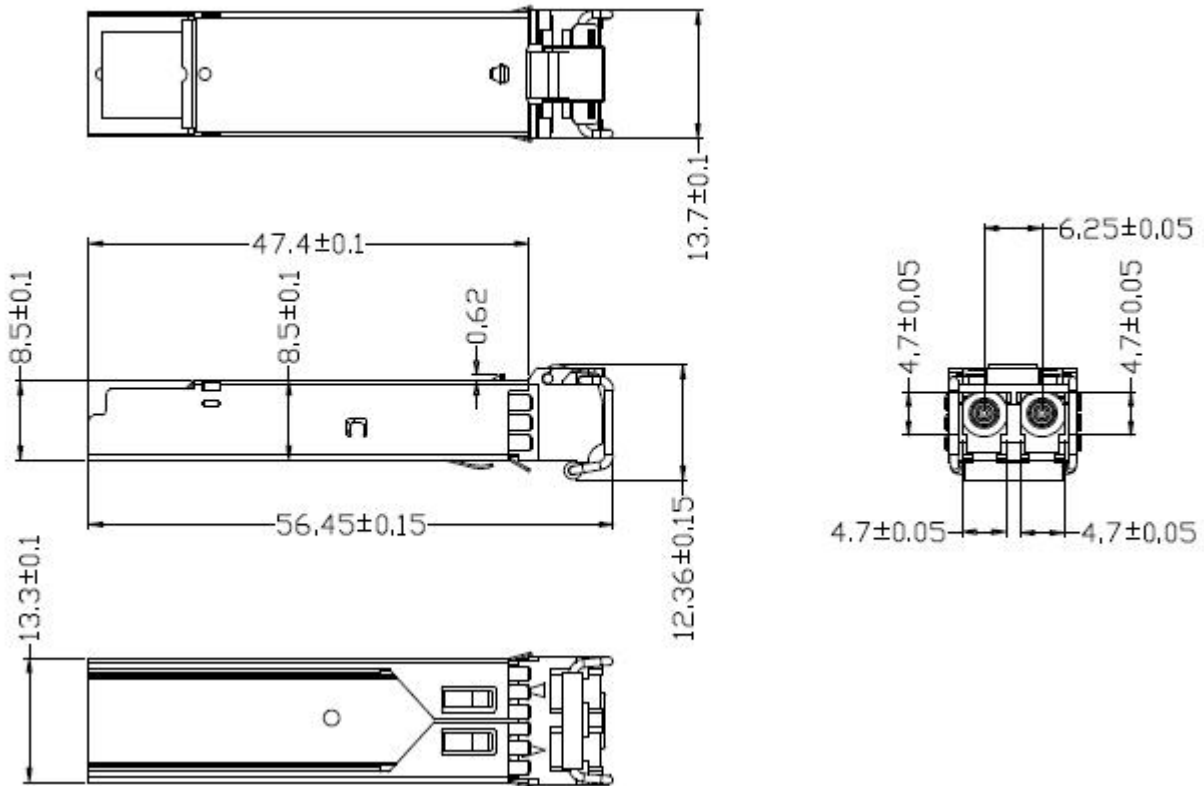
Plug Seq.: Pin engagement sequence during hot plugging.

- 1) TX Fault is an open collector output, which should be pulled up with a 4.7k~10kΩ resistor on the host board to a voltage between 2.0V and V_{cc}+0.3V. Logic 0 indicates normal operation; Logic 1 indicates a laser fault of some kind. In the low state, the output will be pulled to less than 0.8V.
- 2) Laser output disabled on TDIS >2.0V or open, enabled on TDIS <0.8V.
- 3) LOS is open collector output. Should be pulled up with 4.7k~10kΩ on host board to a voltage between 2.0V and 3.6V. Logic 0 indicates normal operation; logic 1 indicates loss of signal.
- 4) RD-/+: These are the differential receiver outputs. They are internally AC-coupled 100 differential lines which should be terminated with 100Ω (differential) at the user SERDES.
- 5) TD-/+: These are the differential transmitter inputs. They are internally AC-coupled, differential lines with 100Ω differential termination inside the module.

Recommended Interface Circuit



Mechanical Dimensions



Ordering information

Part Number	Product Description
LS-MM311G-02AC	1310nm, 1.25Gbps, LC, 2km(MMF), 0°C~+70°C, with DDM
LS-MM311G-02AI	1310nm, 1.25Gbps, LC, 2km(MMF), -40°C~+85°C, with DDM